PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Daeho Shin	07/15/2009
Choonsik Shim	07/15/2009
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Dong-Cheol Shin	07/15/2009
Ho-Seong Lee	07/15/2009

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12557801

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PATENT

REEL: 024792 FRAME: 0126

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ATTORNEY DOCKET NUMBER:	12152-0052
NAME OF SUBMITTER:	Christopher W. Brody
Total Attachments: 2 source=12152-52 assignment1#page1.tif source=12152-52 assignment1#page2.tif	

PATENT REEL: 024792 FRAME: 0127

Docket No.:

ASSIGNMENT This is an Assignment of the following rights, title and interest: ☐ United States of America rights, title and interest in the invention Foreign rights, title and interest in the invention International Application No. Date of Filing: For which an application for a U.S. Patent was executed on_____ United States Patent Application Serial No. Date of Filing: Title of the Invention: Ethylene copolymer and a method of preparing the same Inventors (Assignors): SHIN, DAEHO/ SHIM, CHOONSIK/ JEONG, JISU/ CHAE, SUNGSEOK/ OK, MYUNGAHN /KWON. SEUNGBUM/ SHIN, DONGCHEOL/ LEE, HOSEONG Assignee(s): SK ENERGY CO., LTD. of 99 Seorin-dong, Jongro-gu, Seoul 110-110 Republic of Korea Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention"); And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the aboveidentified assignee: Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged; We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said applications(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States, unto said Assignee. And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto:

And we further agree to sign and execute all necessary and lawful future documents, including applications, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

SHIN, DAEHO	<u>July 15, 2009</u>
Signature: 3	Date
SHIM, CHOONSIK	July 15, 2009
Signature:	Date

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RECORDED: 08/05/2010

Signature:	<u>July 15, 2009</u> Date
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OK, MYUNGAHN Signature: My Sh Ot	<u>July 15, 2009</u> Date
Signature: Total	July 15, 2009 Date
SHIN, Dong-Cheol Signature:	July 15, 2009 Date
LEE, Ho-Seong Signature:	July 15, 2009 Date

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